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## onsemi

## **MOSFET** - Power, Single, N-Channel

60 V, 1.5 mΩ, 238 A

## NTMFS5C612N

#### Features

- Small Footprint (5x6 mm) for Compact Design
- Low RDS(on) to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- NTMFS5C612NWFT1G Wettable Flank Option for Enhanced Optical Inspection
- These Devices are Pb-Free and are RoHS Compliant

Parar	neter		Symbol	Value	Unit
Drain-to-Source Voltage		V <sub>DSS</sub>	60	V	
Gate-to-Source Voltage	Э		V <sub>GS</sub>	±20	V
Continuous Drain	Steady	$T_{C} = 25^{\circ}C$	I <sub>D</sub>	238	А
Current R <sub>θJC</sub> (Notes 1, 3)		T <sub>C</sub> = 100°C		168	
Power Dissipation	State	T <sub>C</sub> = 25°C	PD	170	W
$R_{\theta JC}$ (Note 1)		T <sub>C</sub> = 100°C		84	
Continuous Drain		T <sub>A</sub> = 25°C	۱ <sub>D</sub>	35	А
Current R <sub>θJA</sub> (Notes 1, 2, 3)	Steady State	T <sub>A</sub> = 100°C		25	
Power Dissipation		$T_A = 25^{\circ}C$	PD	3.8	W
$R_{\theta JA}$ (Notes 1, 2)		T <sub>A</sub> = 100°C		1.9	]
Pulsed Drain Current	T <sub>A</sub> = 25	°C, t <sub>p</sub> = 10 μs	I <sub>DM</sub>	900	А
Operating Junction and	Storage T	emperature	T <sub>J</sub> , T <sub>stg</sub>	–55 to +175	°C
Source Current (Body D	)iode)		۱ <sub>S</sub>	190	А
Single Pulse Drain-to-S Energy (I <sub>L(pk)</sub> = 17 A)	Source Av	alanche	E <sub>AS</sub>	451	mJ
Lead Temperature for S (1/8" from case for 10 s		Purposes	ΤL	260	°C

MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS

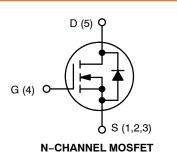
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.9	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	39	

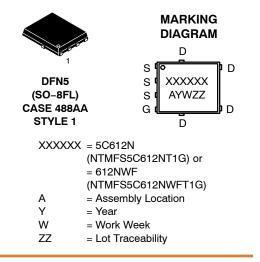
1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650  $\text{mm}^2,$  2 oz. Cu pad.

Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
60 V	1.5 mΩ @ 10 V	238 A





#### **ORDERING INFORMATION**

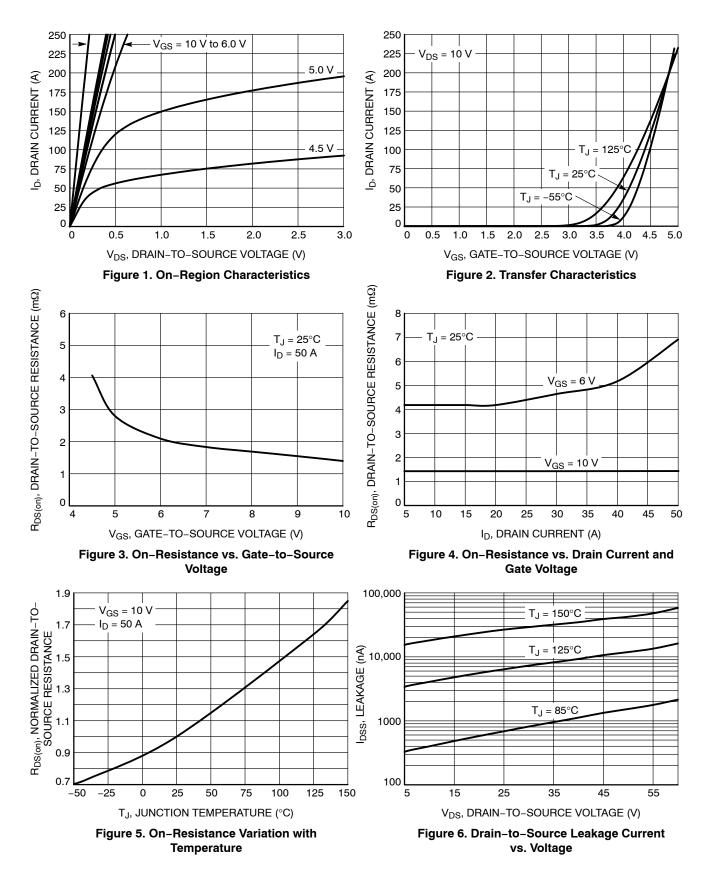
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

NOTE: Some of the device on this data sheet have been **DISCONTINUED**. Please refer to the table on page 5.

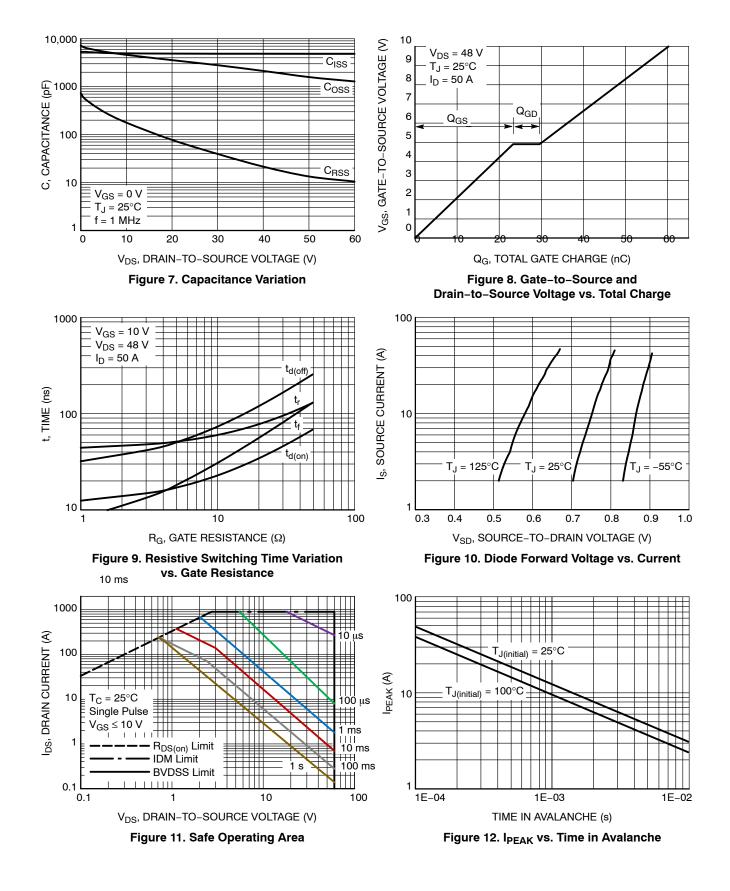
#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> =	= 250 μA	60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> / T <sub>J</sub>				12.8		mV/°0
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$I_{DSS} \qquad \begin{array}{c} V_{GS} = 0 \ V, \\ V_{DS} = 60 \ V \end{array}$	$T_J = 25^{\circ}C$			10	10 250 μA
			T <sub>J</sub> = 125°C			250	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>G</sub>	<sub>S</sub> = 20 V			100	nA
ON CHARACTERISTICS (Note 4)							-
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D$	= 250 μA	2.0		4.0	V
Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				-9.4		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	l <sub>D</sub> = 50 A		1.27	1.5	mΩ
CHARGES, CAPACITANCES & GATE RE	SISTANCE						
Input Capacitance	C <sub>ISS</sub>				4830		
Output Capacitance	C <sub>OSS</sub>	V <sub>GS</sub> = 0 V, f = 1 MH	lz, V <sub>DS</sub> = 25 V		3180		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>				22		
Total Gate Charge	Q <sub>G(TOT)</sub>				60.2		
Threshold Gate Charge	Q <sub>G(TH)</sub>				14.2		
Gate-to-Source Charge	Q <sub>GS</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 48 V; $I_{D}$ = 50 A			23.3		nC
Gate-to-Drain Charge	Q <sub>GD</sub>				6.3		
Plateau Voltage	V <sub>GP</sub>				4.9		V
SWITCHING CHARACTERISTICS (Note 5	5)						
Turn-On Delay Time	t <sub>d(ON)</sub>				14.2		
Rise Time	t <sub>r</sub>	V <sub>GS</sub> = 10 V, V <sub>E</sub>	$h_{0} = 48 \text{ V}$		46.9		ns
Turn-Off Delay Time	t <sub>d(OFF)</sub>	$I_{\rm D} = 50 \rm{A}, \rm{R}_{\rm G}$	$= 2.5 \Omega$		38.9		
Fall Time	t <sub>f</sub>				11.9		
DRAIN-SOURCE DIODE CHARACTERIS	TICS					<u></u>	<u>.</u>
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V,	$T_J = 25^{\circ}C$		0.81	1.0	
		$I_{\rm S} = 50 \rm{A}$	T <sub>J</sub> = 125°C		0.67		V
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, dI <sub>S</sub> /dt = 100 A/µs, I <sub>S</sub> = 50 A			82.4		<u> </u>
Charge Time	ta				40.8		ns
Discharge Time	t <sub>b</sub>				41.6		
Reverse Recovery Charge	Q <sub>RR</sub>				139		nC

#### **TYPICAL CHARACTERISTICS**



#### **TYPICAL CHARACTERISTICS**



#### **TYPICAL CHARACTERISTICS**

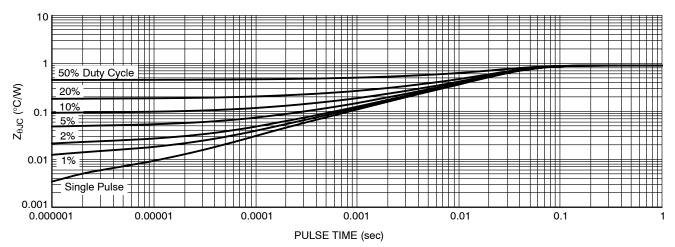


Figure 13. Thermal Characteristics

#### **ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>
NTMFS5C612NT1G	5C612N	DFN5 (Pb–Free)	1500 / Tape & Reel
DISCONTINUED (Note 6)			

NTMFS5C612NWFT1G	612NWF	DFN (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
		(i b i i co, i i ciabio i la lito)	

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

6. DISCONTINUED: This device is not recommended for new design. Please contact your onsemi representative for information. The most current information on this device may be available on www.onsemi.com.

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